

Description

The FDS6990AS uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

VDS = 30V ID = 8.5 A

 $R_{DS(ON)} < 18m\Omega @ V_{GS}=4.5V$

Application

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

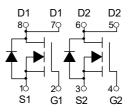
Product ID	Pack	Brand	Qty(PCS)
FDS6990AS	SOP-8	HXY MOSFET	3000

Absolute Maximum Ratings@T_i=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	30	V
V _{GS}	Gate-Source Voltage	<u>+</u> 20	V
I₀@T₄=25℃	Drain Current, V _{GS} @ 4.5V ³	8.5	А
I _D @T _A =70℃	Drain Current, V _{Gs} @ 4.5V ³	5.8	A
Ідм	Pulsed Drain Current ¹	37	A
P _D @T _A =25℃	Total Power Dissipation	1.5	W
Тята	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Rthj-a	Maximum Thermal Resistance, Junction- ambient ³	85	°C/W



SOP-8



Dual N-Channel MOSFET

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V	
$\triangle BV_{\text{DSS}} / \triangle T_{\text{J}}$	$V_{DSS} / \triangle T_J BVDSS$ Temperature Coefficient Reference to 25°C , I _D =1mA			0.034		V/°C	
D	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =7A		15	18	mΩ	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =4.5V , I _D =4A		22	28	1115.2	
V _{GS(th)}	Gate Threshold Voltage		1.2		2.5	V	
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250$ uA		-5.8		mV/°C	
1	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	uA	
I _{DSS}		V _{DS} =24V , V _{GS} =0V , T _J =55°C			5		
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =7A		6		S	
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		2.5		Ω	
Qg	Total Gate Charge (4.5V)			6			
Q _{gs}	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =7A		2.5		nC	
Q _{gd}	Gate-Drain Charge			2.1			
T _{d(on)}	Turn-On Delay Time			2.4			
Tr	Rise Time	V _{DD} =15V , V _{GS} =10V , R _G =3.3Ω		7.8			
T _{d(off)}	Turn-Off Delay Time	I _D =7A		22		ns	
T _f	Fall Time			4			
C _{iss}	Input Capacitance			572			
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		80		pF	
C _{rss}	Reverse Transfer Capacitance			65			
ls	Continuous Source Current ^{1,5}				7.3	А	
I _{SM}	V _G =V _D =0V, Force Current				37	А	
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	V	
t _{rr}	Reverse Recovery Time			20		nS	
Q _{rr}	Reverse Recovery Charge	IF=7A , dI/dt=100A/μs , T _J =25°C		1.1		nC	

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Note :

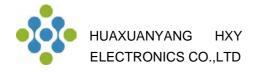
1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, L\text{=}0.1\text{mH}, I_{\text{AS}}\text{=}21\text{A}$

4. The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

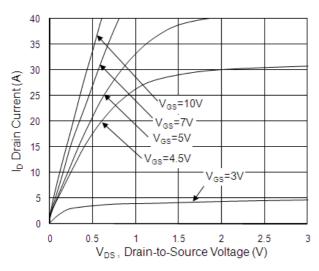


Fig.1 Typical Output Characteristics

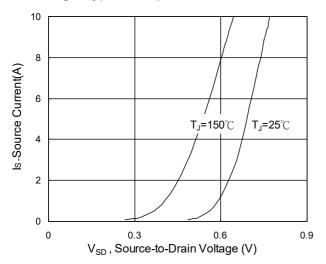


Fig.3 Forward Characteristics Of Reverse

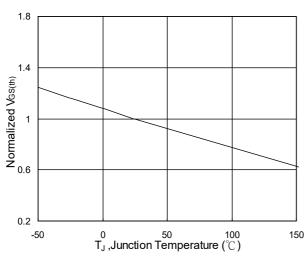


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

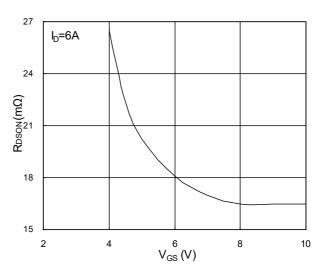


Fig.2 On-Resistance vs. G-S Voltage

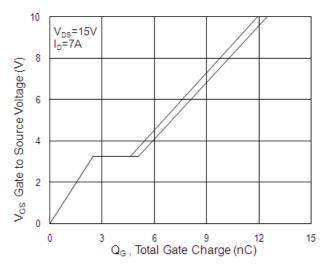


Fig.4 Gate-Charge Characteristics

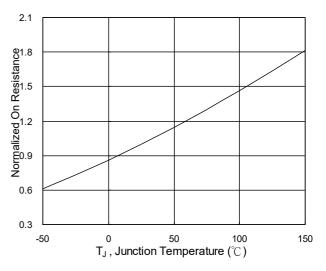


Fig.6 Normalized R_{DSON} vs. T_J



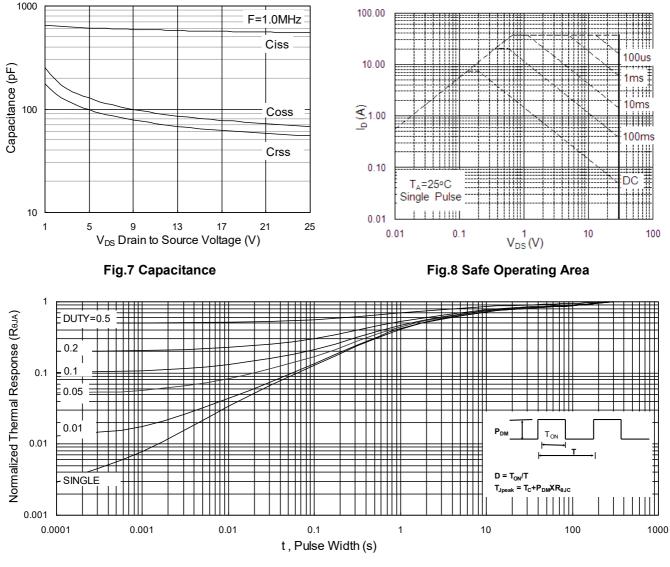


Fig.9 Normalized Maximum Transient Thermal Impedance

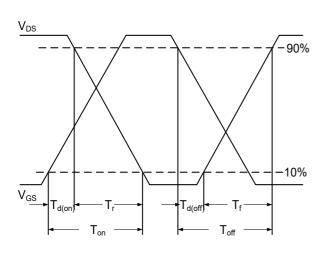


Fig.10 Switching Time Waveform

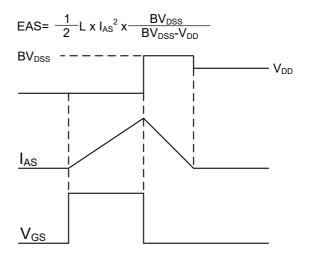
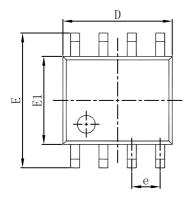
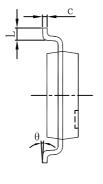


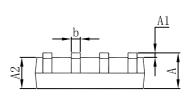
Fig.11 Unclamped Inductive Switching Waveform



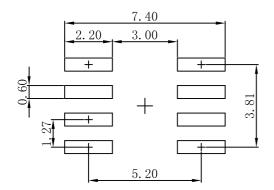
SOP-8 Package Outline Dimensions







Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
e	1.270 ((BSC)	0.050 (BSC)		
E	5.800	6.200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
L	0.400	1.270	0.016	0.050	
θ	0 °	8°	0 °	8°	



Note: 1.Controlling dimension: in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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